

**Government of India**  
**Ministry of Communications**  
**Department of Telecommunications**  
**Telecommunication Engineering Centre**  
**Khurshid Lal Bhawan, Janpath, New Delhi 110001.**

No: 19-08/2023-STD/TEC

Dated 25-01-2023

**Notice for Inviting Public Comments**

**Subject: Inviting public comments on TSDSI transposed 3GPP Release 13 to 17 standard for their adoption into national standards by Telecommunications Engineering Centre (TEC) – reg**

Telecommunications Engineering Centre (TEC), Department of Telecommunication (DOT) has approved a policy for adoption of standards of Telecom Standards Development Society, India (TSDSI)/international standards bodies into national Standards. "Standardisation Guide" – a policy document for adoption of telecom and related ICT standards defines the process of adoption/ratification of TSDSI/international standards like institutional mechanism, process of adoption, maintenance of standards, numbering plan, stakeholder consultation etc

(Refer the Standardization Guide-

<https://www.tec.gov.in/pdf/M2M/Standardisation%20guide.pdf>).

Telecom Standards Advisory Committee (TSAC) – a Standing apex committee under the chairmanship of DDG (Standardisation), TEC in its meeting held on 25-01-2023 has decided to initiate the process of adoption of TSDSI transposed 3GPP specifications Release 13 to 17 (total 1546 documents) as National Standard.

As a next step in adoption process of 3GPP Release 13-17 standard, all the stakeholders are requested to offer their comments on the TSDSI transposed documents. The details in this regard are as given below:

<b>S. No</b>	<b>Item</b>	<b>Description</b>
i.	Adoption of Standards	Seeking public comments on TSDSI's 3GPP Rel. 13-17 standard
ii.	Division	Standardisation Division, TEC

iii.	Date of Release	25 January 2023
iv.	Date of Closing	24 February 2023
v.	Comments to be mailed to	<a href="mailto:dirsted.tec-dot@gov.in">dirsted.tec-dot@gov.in</a> , <a href="mailto:adgs.tec-dot@gov.in">adgs.tec-dot@gov.in</a>
vi	Document	<b>Documents available at Annexure-I</b>

All the stakeholders are requested to mail their comments by 24.02.2023 at [dirsted.tec-dot@gov.in](mailto:dirsted.tec-dot@gov.in) , [adgs.tec-dot@gov.in](mailto:adgs.tec-dot@gov.in) . It may be kept into consideration while offering the comments that only technical content or the amendments affecting the technical content of standard shall be open for public comments, as per Para 6.2.4 of the Standardisation Guide.

For any query or clarification, please contact [dirsted.tec-dot@gov.in](mailto:dirsted.tec-dot@gov.in)

  
25/1/2023

(J. L. Gupta)  
Director (Std.)

Telecommunication Engineer Centre

Email: [dirsted.tec-dot@gov.in](mailto:dirsted.tec-dot@gov.in)

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To,

- i) Director (IT), TEC to upload the notice on TEC website for public comments
- ii) Director (IT), to upload the notice on DoT website for public comments
- iii) DG, TSDSI to upload the notice on TSDSI website for public comments

## Annexure-I

The following table contains the list of transposed standards along with the URL of the file folders for each Release:

<b>Releases</b>	<b>Number of Specifications</b>	<b>Links</b>
Release 13	506	<a href="https://members.tsdSI.in/s/Mek6TMFrapywg2B">https://members.tsdSI.in/s/Mek6TMFrapywg2B</a>
Release 14	578	<a href="https://members.tsdSI.in/s/RKqaEaBrG3JnqyP">https://members.tsdSI.in/s/RKqaEaBrG3JnqyP</a>
Release 15	91	<a href="https://members.tsdSI.in/s/3CJq6QgX5sPBTrm">https://members.tsdSI.in/s/3CJq6QgX5sPBTrm</a>
Release 16	105	<a href="https://members.tsdSI.in/s/XAKs5ndZ9wcDNY9">https://members.tsdSI.in/s/XAKs5ndZ9wcDNY9</a>
Release 17	266	<a href="https://members.tsdSI.in/s/eN6Wx85ZQ7NTNxE">https://members.tsdSI.in/s/eN6Wx85ZQ7NTNxE</a>
<b>Total</b>	<b>1546</b>	